Renesas Electronics America Inc - R5F2LA88ADFP#V0 Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	R8C
Core Size	16-Bit
Speed	20MHz
Connectivity	I²C, LINbus, SIO, SSU, UART/USART
Peripherals	LCD, POR, PWM, Voltage Detect, WDT
Number of I/O	72
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	3.5K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f2la88adfp-v0

Table 1.4 LCD Display Function Pins Provided for Each Group (R8C/LA3A Group, R8C/LA5A Group)

Shared I/O Port	R8C/LA3A Group Common output: Max. 4 Segment output: Max. 11								R8C/LA5A Group Common output: Max. 4 Segment output: Max. 27							
P0	—	—	—	—	—	—	—	—	SEG 7	SEG 6	SEG 5	SEG 4	SEG 3	SEG 2	SEG 1	SEG 0
P2	SEG 15	SEG 14	SEG 13	SEG 12	SEG 11	SEG 10	SEG 9	SEG 8	SEG 15	SEG 14	SEG 13	SEG 12	SEG 11	SEG 10	SEG 9	SEG 8
P3	—	—	—	—	—	—	—	—	SEG 23	SEG 22	SEG 21	SEG 20	SEG 19	SEG 18	SEG 17	SEG 16
P5	—	VL3 (2)	VL2 (2)	VL1 (2)	COM 0	COM 1 SEG 26	COM 2 SEG 25	COM 3 SEG 24	—	VL3 (2)	VL2 (2)	VL1 (2)	COM 0	COM 1 SEG 26	COM 2 SEG 25	COM 3 SEG 24

Notes:
1. The symbol "—" indicates there is no LCD display function. Set the corresponding bits to 0 by setting registers LSE0, LSE2, and LSE5 for these pins.
2. When using the LCD drive control circuit, set the corresponding bit in the LSE5 register to 1.

Table 1.5 LCD Display Function Pins Provided for Each Group (R8C/LA6A Group, R8C/LA8A Group)

Shared I/O Port	R8C/LA6A Group Common output: Max. 4 Segment output: Max. 32								R8C/LA8A Group Common output: Max. 4 Segment output: Max. 40							
P0	SEG 7	SEG 6	SEG 5	SEG 4	SEG 3	SEG 2	SEG 1	SEG 0	SEG 7	SEG 6	SEG 5	SEG 4	SEG 3	SEG 2	SEG 1	SEG 0
P1	SEG 15	SEG 14	SEG 13	SEG 12	SEG 11	SEG 10	—	—	SEG 15	SEG 14	SEG 13	SEG 12	SEG 11	SEG 10	SEG 9	SEG 8
P2	SEG 23	SEG 22	SEG 21	SEG 20	SEG 19	SEG 18	SEG 17	SEG 16	SEG 23	SEG 22	SEG 21	SEG 20	SEG 19	SEG 18	SEG 17	SEG 16
P3	SEG 31	SEG 30	SEG 29	SEG 28	SEG 27	SEG 26	SEG 25	SEG 24	SEG 31	SEG 30	SEG 29	SEG 28	SEG 27	SEG 26	SEG 25	SEG 24
P4	SEG 39	SEG 38	—	—	—	—	—	—	SEG 39	SEG 38	SEG 37	SEG 36	SEG 35	SEG 34	SEG 33	SEG 32
P5	—	VL3 (2)	VL2 (2)	VL1 (2)	COM 0	COM 1	COM 2	COM 3	—	VL3 (2)	VL2 (2)	VL1 (2)	COM 0	COM 1	COM 2	COM 3

Notes:
1. The symbol "—" indicates there is no LCD display function. Set the corresponding bits to 0 by setting registers LSE1, LSE4 and LSE5 for these pins.
2. When using the LCD drive control circuit, set the corresponding bit in the LSE5 register to 1.

Table 1.10 Product List for R8C/LA5A Group **Current of Oct 2011**

Part No.	Internal ROM Capacity		Internal RAM Capacity	Package Type	Remarks
	Program ROM	Data Flash			
R5F2LA52ANFP	8 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	N Version
R5F2LA54ANFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	
R5F2LA56ANFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	
R5F2LA58ANFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0052JA-A	
R5F2LA52ADFP	8 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	D Version
R5F2LA54ADFP	16 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	
R5F2LA56ADFP	32 Kbytes	1 Kbyte × 2	2 Kbytes	PLQP0052JA-A	
R5F2LA58ADFP	64 Kbytes	1 Kbyte × 2	3.5 Kbytes	PLQP0052JA-A	

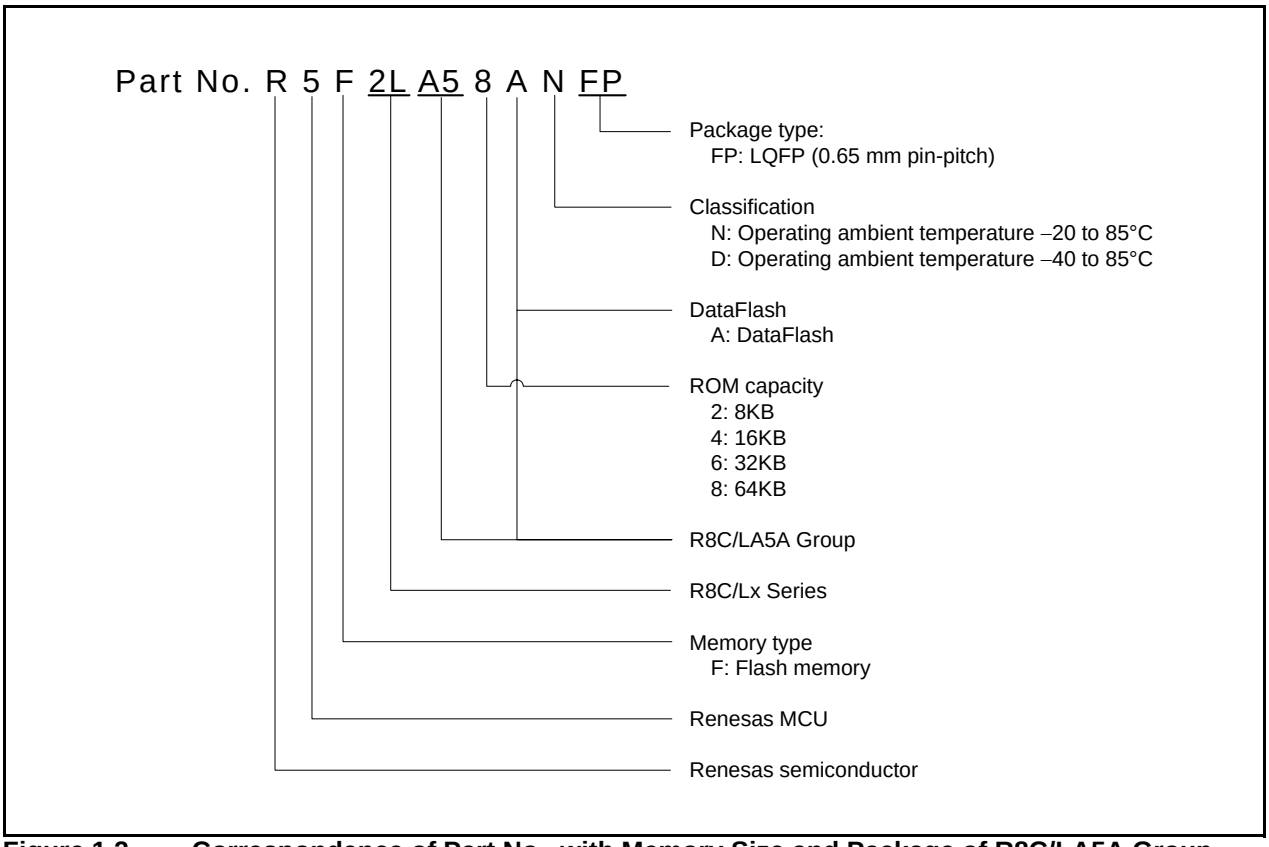


Figure 1.2 Correspondence of Part No., with Memory Size and Package of R8C/LA5A Group

Table 1.14 Pin Name Information by Pin Number (R8C/LA3A Group, R8C/LA5A Group)(2)

Pin Number		Control Pin	Port	I/O Pin Functions for Peripheral Modules						
LA5A	LA3A			Interrupt	Timer	Serial Interface	SSU	I²C bus	A/D Converter, Comparator B	LCD drive Control Circuit
31			P3_0							SEG16
32	19		P2_7	$\overline{KI3}$						SEG15/ COMEXP
33	20		P2_6	($\overline{INT3}$)/$\overline{KI2}$						SEG14
34	21		P2_5	($\overline{INT2}$)/$\overline{KI1}$						SEG13
35	22		P2_4	($\overline{INT1}$)/$\overline{KI0}$						SEG12
36	23		P2_3	$\overline{INT5}$						SEG11
37	24		P2_2	$\overline{INT0}$						SEG10
38	25		P2_1		TRB0O					SEG9
39	26		P2_0		TRB1O					SEG8
40			P0_7		TRHO					SEG7
41			P0_6				$\overline{SCS}$			SEG6
42			P0_5				SSI			SEG5
43			P0_4				SSCK	SCL		SEG4
44			P0_3				SSO	SDA		SEG3
45			P0_2							SEG2
46			P0_1							SEG1
47			P0_0	$\overline{INT7}$	(TRCTRG)				$\overline{ADTRG}$	SEG0
48			P7_2		(TRCTRG)				AN6	
49	27		P7_1	$\overline{INT2}$	TRCCLK				AN5	
50		$\overline{WKUP1}$	P7_0						AN4/IVREF3	
51	28		P8_7		TRCIOA/ (TRCTRG)				AN3/IVREF1	
52	29		P8_6		(TRCIOB)	RXD0			AN2	

Note:
1. The pin in parentheses can be assigned by a program.

Table 1.15 Pin Name Information by Pin Number (R8C/LA6A Group, R8C/LA8A Group)(1)

Pin Number		Control Pin	Port	I/O Pin Functions for Peripheral Modules						
LA8A	LA6A			Interrupt	Timer	Serial Interface	SSU	I²C bus	A/D Converter, Comparator B	LCD drive Control Circuit
1			P7_1		TRJ1O	(TXD2/SDA2/RXD2/SCL2)				
2		$\overline{\text{WKUP1}}$	P7_0		TRJ2O	(CLK2)				
3	64		P8_7	$\overline{\text{INT2}}$	TRB0O	($\overline{\text{CTS2}}$/$\overline{\text{RTS2}}$)				
4	1	$\overline{\text{WKUP0}}$								
5	2	VREF								
6	3	MODE								
7	4	XCIN								
8	5	XCOUT								
9	6	$\overline{\text{RESET}}$								
10	7	XOUT	P9_1							
11	8	VSS/ AVSS								
12	9	XIN	P9_0							
13	10	VCC/ AVCC								
14	11		P8_6			(RXD0/RXD2/SCL2)				
15	12		P8_5			(TXD0/TXD2/SDA2)				
16	13		P8_4			(CLK0/CLK2)				
17	14		P8_3		(TRJ0IO)		SSO	SDA		
18	15		P8_2		(TRJ1IO)		SSCK	SCL		
19	16		P8_1	$\overline{\text{INT3}}$			SSI		IVCMP3	
20	17		P8_0	$\overline{\text{INT1}}$			$\overline{\text{SCS}}$		IVCMP1	
21	18		P5_6							VL3
22	19		P5_5							VL2
23	20		P5_4							VL1
24	21		P5_3							COM0
25	22		P5_2							COM1
26	23		P5_1							COM2
27	24		P5_0							COM3
28	25		P4_7							SEG39/ COMEXP
29	26		P4_6							SEG38
30			P4_5							SEG37

Note:
1. The pin in parentheses can be assigned by a program.

1.5 Pin Functions

Tables 1.18 and 1.19 list Pin Functions for R8C/LA5A Group, and Tables 1.20 and 1.21 list Pin Functions for R8C/LA8A Group.

Table 1.18 Pin Functions for R8C/LA5A Group (1)

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	—	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Driving this pin low resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
Power-off 0 mode exit input	$\overline{\text{WKUP0}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode. Connect to VSS when not using power-off 0 mode.
	$\overline{\text{WKUP1}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic oscillator or a crystal oscillator between pins XIN and XOUT. (1) To use an external clock, input it to the XIN pin and set XOUT as the I/O port P9_1. When the pin is not used, treat it as an unassigned pin and use the appropriate handling.
XIN clock output	XOUT	O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between pins XCIN and XCOUT. (1) To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT3}}$, $\overline{\text{INT5}}$, $\overline{\text{INT7}}$	I	$\overline{\text{INT}}$ interrupt input pins.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI7}}$	I	Key input interrupt input pins.
Timer RB	TRB0O, TRB1O	O	Timer RB output pins.
Timer RC	TRCCLK	I	External clock input pin.
	TRCTRG	I	External trigger input pin.
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins.
Timer RH	TRHO	O	Timer RH output pin.
Timer RJ	TRJ0IO, TRJ1IO	I/O	Timer RJ I/O pins.
Serial interface	CLK0	I/O	Transfer clock I/O pin.
	RXD0	I	Serial data input pin.
	TXD0	O	Serial data output pin.

I: Input O: Output I/O: Input and output

Note:

1. Contact the oscillator manufacturer for oscillation characteristics.

Table 1.20 Pin Functions for R8C/LA8A Group (1)

Item	Pin Name	I/O Type	Description
Power supply input	VCC, VSS	—	Apply 1.8 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	—	Power supply for the A/D converter. Connect a capacitor between AVCC and AVSS.
Reset input	$\overline{\text{RESET}}$	I	Driving this pin low resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
Power-off 0 mode exit input	$\overline{\text{WKUP0}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode. Connect to VSS when not using power-off 0 mode.
	$\overline{\text{WKUP1}}$	I	This pin is provided for input to exit the mode used in power-off 0 mode.
XIN clock input	XIN	I	These pins are provided for XIN clock generation circuit I/O. Connect a ceramic oscillator or a crystal oscillator between pins XIN and XOUT. (1) To use an external clock, input it to the XIN pin and set XOUT as the I/O port P9_1. When the pin is not used, treat it as an unassigned pin and use the appropriate handling.
XIN clock output	XOUT	O	
XCIN clock input	XCIN	I	These pins are provided for XCIN clock generation circuit I/O. Connect a crystal oscillator between pins XCIN and XCOUT. (1) To use an external clock, input it to the XCIN pin and leave the XCOUT pin open.
XCIN clock output	XCOUT	O	
$\overline{\text{INT}}$ interrupt input	$\overline{\text{INT0}}$ to $\overline{\text{INT7}}$	I	$\overline{\text{INT}}$ interrupt input pins.
Key input interrupt	$\overline{\text{KI0}}$ to $\overline{\text{KI7}}$	I	Key input interrupt input pins.
Timer RB	TRB0O, TRB1O	O	Timer RB output pins.
Timer RC	TRCCLK	I	External clock input pin.
	TRCTRG	I	External trigger input pin.
	TRCIOA, TRCIOB, TRCIOC, TRCIOD	I/O	Timer RC I/O pins.
Timer RH	TRHO	O	Timer RH output pin.
Timer RJ	TRJ0IO, TRJ1IO, TRJ2IO	I/O	Timer RJ I/O pins.
	TRJ0IO, TRJ1IO, TRJ2IO	O	Timer RJ output pins.
Serial interface	CLK0, CLK2	I/O	Transfer clock I/O pin.
	RXD0, RXD2	I	Serial data input pin.
	TXD0, TXD2	O	Serial data output pin.
	$\overline{\text{CTS2}}$	I	Transmission control input pin.
	$\overline{\text{RTS2}}$	O	Reception control output pin.
	SCL2	I/O	I^2C mode clock I/O pin.
	SDA2	I/O	I^2C mode data I/O pin.

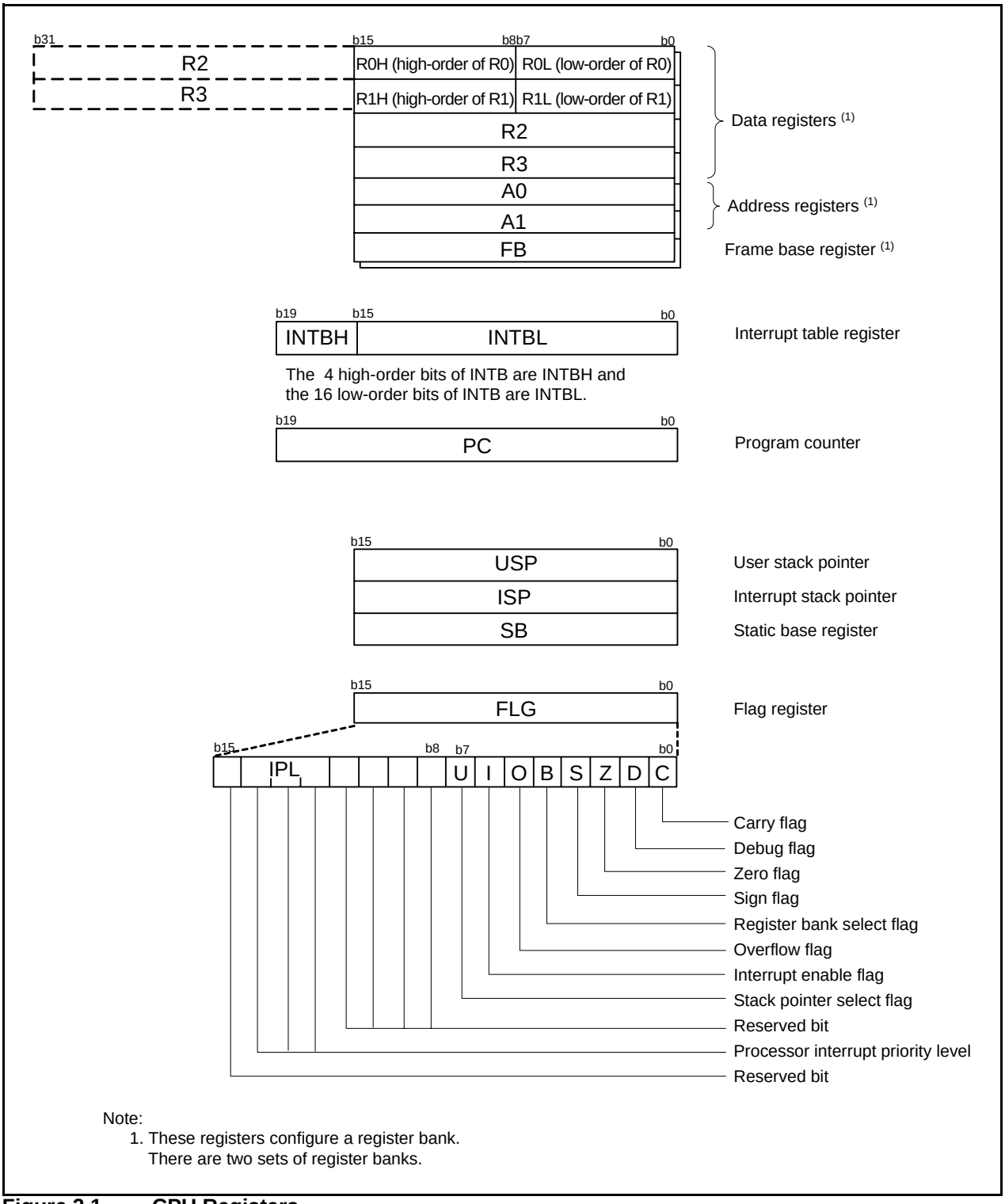
I: Input O: Output I/O: Input and output

Note:

1. Contact the oscillator manufacturer for oscillation characteristics.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register banks.



Note:
1. These registers configure a register bank.
There are two sets of register banks.

Figure 2.1 CPU Registers

Table 4.2 SFR Information for R8C/LA5A Group (2) (1)

Address	Register	Symbol	After Reset
003Ah	Voltage Monitor 2 Circuit Control Register	VW2C	10000010b
003Bh			
003Ch			
003Dh			
003Eh			
003Fh			
0040h			
0041h	Flash Memory Ready Interrupt Control Register	FMRDYIC	XXXXX000b
0042h			
0043h	INT7 Interrupt Control Register	INT7IC	XX00X000b
0044h			
0045h	INT5 Interrupt Control Register	INT5IC	XX00X000b
0046h			
0047h	Timer RC Interrupt Control Register	TRCIC	XXXXX000b
0048h			
0049h			
004Ah	Timer RH Interrupt Control Register	TRHIC	XXXXX000b
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	A/D Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh	SSU Interrupt Control Register / IIC bus Interrupt Control Register (2)	SSUIC/IICIC	XXXXX000b
0050h			
0051h	UART0 Transmit Interrupt Control Register	S0TIC	XXXXX000b
0052h	UART0 Receive Interrupt Control Register	S0RIC	XXXXX000b
0053h			
0054h			
0055h	INT2 Interrupt Control Register	INT2IC	XX00X000b
0056h	Timer RJ0 Interrupt Control Register	TRJ0IC	XXXXX000b
0057h	Timer RB1 Interrupt Control Register	TRB1IC	XXXXX000b
0058h	Timer RB0 Interrupt Control Register	TRB0IC	XXXXX000b
0059h	INT1 Interrupt Control Register	INT1IC	XX00X000b
005Ah	INT3 Interrupt Control Register	INT3IC	XX00X000b
005Bh	Timer RJ1 Interrupt Control Register	TRJ1IC	XXXXX000b
005Ch			
005Dh	INT0 Interrupt Control Register	INT0IC	XX00X000b
005Eh			
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h			
0068h			
0069h			
006Ah	LCD Interrupt Control Register	LCDIC	XXXXX000b
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h	Voltage monitor 1 Interrupt Control Register	VCMP1IC	XXXXX000b
0073h	Voltage monitor 2 Interrupt Control Register	VCMP2IC	XXXXX000b
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

Notes:

1. Blank spaces are reserved. No access is allowed.
2. Selectable by the IICSEL bit in the SSUIICSR register.

Table 4.12 SFR Information for R8C/LA8A Group (3) (1)

Address	Register	Symbol	After Reset
0080h	Timer RJ0 Control Register	TRJ0CR	00h
0081h	Timer RJ0 I/O Control Register	TRJ0IOC	00h
0082h	Timer RJ0 Mode Register	TRJ0MR	00h
0083h	Timer RJ0 Event Pin Select Register	TRJ0ISR	00h
0084h	Timer RJ0 Register	TRJ0	FFh
0085h			FFh
0086h			
0087h			
0088h	Timer RJ1 Control Register	TRJ1CR	00h
0089h	Timer RJ1 I/O Control Register	TRJ1IOC	00h
008Ah	Timer RJ1 Mode Register	TRJ1MR	00h
008Bh	Timer RJ1 Event Pin Select Register	TRJ1ISR	00h
008Ch	Timer RJ1 Register	TRJ1	FFh
008Dh			FFh
008Eh			
008Fh			
0090h	Timer RJ2 Control Register	TRJ2CR	00h
0091h	Timer RJ2 I/O Control Register	TRJ2IOC	00h
0092h	Timer RJ2 Mode Register	TRJ2MR	00h
0093h	Timer RJ2 Event Pin Select Register	TRJ2ISR	00h
0094h	Timer RJ2 Register	TRJ2	FFh
0095h			FFh
0096h			
0097h			
0098h	Timer RB1 Control Register	TRB1CR	00h
0099h	Timer RB1 One-Shot Control Register	TRB1OCR	00h
009Ah	Timer RB1 I/O Control Register	TRB1IOC	00h
009Bh	Timer RB1 Mode Register	TRB1MR	00h
009Ch	Timer RB1 Prescaler Register	TRB1PRE	FFh
009Dh	Timer RB1 Secondary Register	TRB1SC	FFh
009Eh	Timer RB1 Primary Register	TRB1PR	FFh
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UART0 Bit Rate Register	U0BRG	XXh
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h			XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART2 Transmit/Receive Mode Register	U2MR	00h
00A9h	UART2 Bit Rate Register	U2BRG	XXh
00AAh	UART2 Transmit Buffer Register	U2TB	XXh
00ABh			XXh
00ACh	UART2 Transmit/Receive Control Register 0	U2C0	00001000b
00ADh	UART2 Transmit/Receive Control Register 1	U2C1	00000010b
00AEh	UART2 Receive Buffer Register	U2RB	XXh
00AFh			XXh
00B0h	UART2 Digital Filter Function Select Register	URXDF	00h
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			
00B6h			
00B7h			
00B8h			
00B9h			
00BAh			
00BBh	UART2 Special Mode Register 5	U2SMR5	00h
00BCh	UART2 Special Mode Register 4	U2SMR4	00h
00BDh	UART2 Special Mode Register 3	U2SMR3	000X0X0Xb
00BEh	UART2 Special Mode Register 2	U2SMR2	X0000000b
00BFh	UART2 Special Mode Register	U2SMR	X0000000b

X: Undefined

Note:

1. Blank spaces are reserved. No access is allowed.

5. Electrical Characteristics

5.1 Electrical Characteristics (R8C/LA3A Group and R8C/LA5A Group)

5.1.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter		Condition	Rated Value	Unit
V_{CC}/AV_{CC}	Supply voltage			–0.3 to 6.5	V
V_I	Input voltage	XIN	XIN-XOUT oscillation on (oscillation buffer ON) (1)	–0.3 to 1.9	V
		XIN	XIN-XOUT oscillation on (oscillation buffer OFF) (1)	–0.3 to V_{CC} + 0.3	V
		P5_4/VL1		–0.3 to VL2 (2)	V
		P5_5/VL2		VL1 to VL3	V
		P5_6/VL3		VL2 to 6.5	V
		Other pins		–0.3 to V_{CC} + 0.3	V
V_O	Output voltage	XOUT	XIN-XOUT oscillation on (oscillation buffer ON) (1)	–0.3 to 1.9	V
		XOUT	XIN-XOUT oscillation on (oscillation buffer OFF) (1)	–0.3 to V_{CC} + 0.3	V
		COM0 to COM3		–0.3 to VL3	V
		SEG0 to SEG26		–0.3 to VL3	V
		Other pins		–0.3 to V_{CC} + 0.3	V
P_d	Power dissipation		–40 °C ≤ T_{opr} ≤ 85 °C	500	mW
T_{opr}	Operating ambient temperature			–20 to 85 (N version)/ –40 to 85 (D version)	°C
T_{stg}	Storage temperature			–65 to 150	°C

Notes:
1. For the register settings for each operation, refer to **7. I/O Ports** and **9. Clock Generation Circuit** in the User's Manual: Hardware.
2. The VL1 voltage should be VCC or below.

Table 5.5 Gain Amplifier Characteristics
(V_{SS} = 0 V and T_{opr} = –20 to 85 °C (N version)/ –40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
V_{GAIN}	Gain amplifier operating range		0.4	—	AV_{CC} – 1.0	V
ϕAD	A/D conversion clock		1	—	5	MHz

Table 5.6 Comparator B Characteristics
(V_{CC} = 1.8 to 5.5 V and T_{opr} = –20 to 85 °C (N version)/ –40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
Vref	IVREF1, IVREF3 input reference voltage		0	–	V_{CC} – 1.4	V
V_I	IVCMP1, IVCMP3 input voltage		–0.3	–	V_{CC} + 0.3	V
–	Offset		–	5	100	mV
t_d	Comparator output delay time (1)	V_I = Vref ± 100 mV	–	–	1	µs
I_{CMP}	Comparator operating current	V_{CC} = 5.0 V	–	12	–	µA

Note:
1. When the digital filter is disabled.

Table 5.9 Voltage Detection 0 Circuit Characteristics (Vcc = 1.8 to 5.5 V and Topr = –20 to 85 °C (N version)/ –40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit
				Min.	Typ.	Max.	
V_{det0}	Voltage detection level Vdet0_0 (1)			1.8	1.90	2.05	V
	Voltage detection level Vdet0_1 (1)			2.15	2.35	2.50	V
	Voltage detection level Vdet0_2 (1)			2.70	2.85	3.05	V
	Voltage detection level Vdet0_3 (1)			3.55	3.80	4.05	V
–	Voltage detection 0 circuit response time (3)	In operation	At the falling of Vcc from 5 V to (Vdet0_0 – 0.1) V	–	50	500	µs
		In stop mode	At the falling of Vcc from 5 V to (Vdet0_0 – 0.1) V	–	100	500	µs
–	Voltage detection circuit self power consumption	VCA25 = 1, Vcc = 5.0 V		–	1.5	–	µA
$t_{d(E-A)}$	Waiting time until voltage detection circuit operation starts (2)			–	–	100	µs

Notes:
1. Select the voltage detection level with bits VDSEL0 and VDSEL1 in the OFS register.
2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0.
3. Time until the voltage monitor 0 reset is generated after the voltage passes V_{det0}.

Table 5.10 Voltage Detection 1 Circuit Characteristics (Vcc = 1.8 to 5.5 V and Topr = –20 to 85 °C (N version)/ –40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter	Condition		Standard			Unit
				Min.	Typ.	Max.	
V_{det1}	Voltage detection level Vdet1_0 (1)	At the falling of Vcc		2.00	2.20	2.40	V
	Voltage detection level Vdet1_1 (1)	At the falling of Vcc		2.15	2.35	2.55	V
	Voltage detection level Vdet1_2 (1)	At the falling of Vcc		2.30	2.50	2.70	V
	Voltage detection level Vdet1_3 (1)	At the falling of Vcc		2.45	2.65	2.85	V
	Voltage detection level Vdet1_4 (1)	At the falling of Vcc		2.60	2.80	3.00	V
	Voltage detection level Vdet1_5 (1)	At the falling of Vcc		2.75	2.95	3.15	V
	Voltage detection level Vdet1_6 (1)	At the falling of Vcc		2.85	3.10	3.40	V
	Voltage detection level Vdet1_7 (1)	At the falling of Vcc		3.00	3.25	3.55	V
	Voltage detection level Vdet1_8 (1)	At the falling of Vcc		3.15	3.40	3.70	V
	Voltage detection level Vdet1_9 (1)	At the falling of Vcc		3.30	3.55	3.85	V
	Voltage detection level Vdet1_A (1)	At the falling of Vcc		3.45	3.70	4.00	V
	Voltage detection level Vdet1_B (1)	At the falling of Vcc		3.60	3.85	4.15	V
	Voltage detection level Vdet1_C (1)	At the falling of Vcc		3.75	4.00	4.30	V
	Voltage detection level Vdet1_D (1)	At the falling of Vcc		3.90	4.15	4.45	V
	Voltage detection level Vdet1_E (1)	At the falling of Vcc		4.05	4.30	4.60	V
	Voltage detection level Vdet1_F (1)	At the falling of Vcc		4.20	4.45	4.75	V
–	Hysteresis width at the rising of Vcc in voltage detection 1 circuit	Vdet1_0 to Vdet1_5 selected		–	0.07	–	V
		Vdet1_6 to Vdet1_F selected		–	0.10	–	V
–	Voltage detection 1 circuit response time (2)	In operation	At the falling of Vcc from 5 V to (Vdet1_0 – 0.1) V	–	60	150	µs
		In stop mode	At the falling of Vcc from 5 V to (Vdet1_0 – 0.1) V	–	250	500	µs
–	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V		–	1.7	–	µA
$t_{d(E-A)}$	Waiting time until voltage detection circuit operation starts (3)			–	–	100	µs

Notes:
1. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
2. Time until the voltage monitor 1 interrupt request is generated after the voltage passes V_{det1}.
3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.

5.1.5 AC Characteristics

Table 5.24 Timing Requirements of Synchronous Serial Communication Unit (SSU) (V_{CC} = 1.8 to 5.5 V, V_{SS} = 0 V, and T_{opr} = −20 to 85 °C (N version)/ −40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter		Conditions	Standard			Unit
				Min.	Typ.	Max.	
t_{SUCYC}	SSCK clock cycle time			4	–	-	t_{CYC} (1)
t_{HI}	SSCK clock “H” width			0.4	–	0.6	t_{SUCYC}
t_{LO}	SSCK clock “L” width			0.4	–	0.6	t_{SUCYC}
t_{RISE}	SSCK clock rising time	Master		–	–	1	t_{CYC} (1)
		Slave		–	–	1	µs
t_{FALL}	SSCK clock falling time	Master		–	–	1	t_{CYC} (1)
		Slave		–	–	1	µs
t_{SU}	SSO, SSI data input setup time			100	–	–	ns
t_H	SSO, SSI data input hold time			1	–	–	t_{CYC} (1)
t_{LEAD}	$\overline{SCS}$ setup time	Slave		1t_{CYC} + 50	–	–	ns
t_{LAG}	$\overline{SCS}$ hold time	Slave		1t_{CYC} + 50	–	–	ns
t_{OD}	SSO, SSI data output delay time			–	–	1t_{CYC} + 20	ns
t_{SA}	SSI slave access time		2.7 V ≤ V_{CC} ≤ 5.5 V	–	–	1.5t_{CYC} + 100	ns
			1.8 V ≤ V_{CC} < 2.7 V	–	–	1.5t_{CYC} + 200	ns
t_{OR}	SSI slave out open time		2.7 V ≤ V_{CC} ≤ 5.5 V	–	–	1.5t_{CYC} + 100	ns
			1.8 V ≤ V_{CC} < 2.7 V	–	–	1.5t_{CYC} + 200	ns

Note:
1. 1t_{CYC} = 1/f1(s)

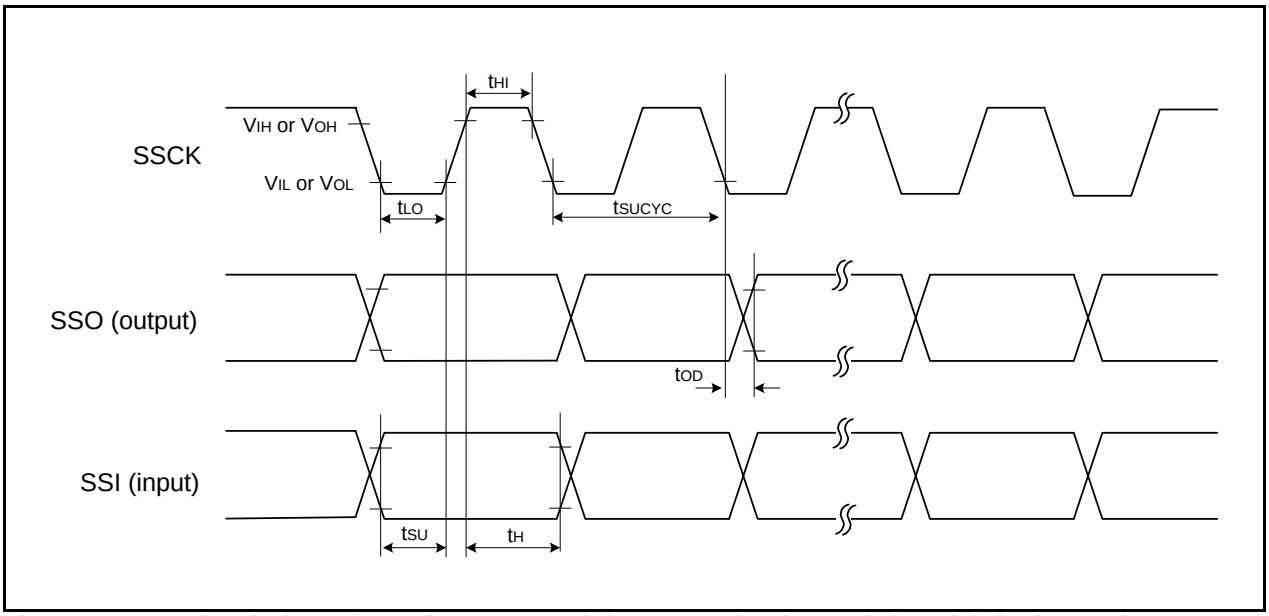


Figure 5.6 I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)

5.2.3 Peripheral Function Characteristics

Table 5.32 A/D Converter Characteristics
(Vcc/AVcc = Vref = 1.8 to 5.5 V, Vss = 0 V, and Topr = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter		Conditions		Standard			Unit
					Min.	Typ.	Max.	
–	Resolution		Vref = AVcc		–	–	10	Bit
–	Absolute accuracy (2)	10-bit mode	Vref = AVcc = 5.0 V	AN0 to AN11 input	–	–	±3	LSB
			Vref = AVcc = 2.2 V	AN0 to AN11 input	–	–	±5	LSB
			Vref = AVcc = 1.8 V	AN0 to AN11 input	–	–	±5	LSB
		8-bit mode	Vref = AVcc = 5.0 V	AN0 to AN11 input	–	–	±2	LSB
			Vref = AVcc = 2.2 V	AN0 to AN11 input	–	–	±2	LSB
			Vref = AVcc = 1.8 V	AN0 to AN11 input	–	–	±2	LSB
ϕAD	A/D conversion clock		4.0 ≤ Vref = AVcc ≤ 5.5 V (1)		1	–	20	MHz
			3.2 ≤ Vref = AVcc ≤ 5.5 V (1)		1	–	16	MHz
			2.7 ≤ Vref = AVcc ≤ 5.5 V (1)		1	–	10	MHz
			1.8 ≤ Vref = AVcc ≤ 5.5 V (1)		1	–	8	MHz
–	Tolerance level impedance				–	3	–	kΩ
tCONV	Conversion time	10-bit mode	Vref = AVcc = 5.0 V, ϕAD = 20 MHz		2.2	–	–	µs
		8-bit mode	Vref = AVcc = 5.0 V, ϕAD = 20 MHz		2.2	–	–	ms
tSAMP	Sampling time		ϕAD = 20 MHz		0.8	–	–	µs
IVref	Vref current		Vcc = 5 V, XIN = f1 = ϕAD = 20 MHz		-	45	–	µA
Vref	Reference voltage				1.8	–	AVcc	V
VIA	Analog input voltage (3)				0	–	Vref	V
OCVREF	On-chip reference voltage		2 MHz ≤ ϕAD ≤ 4 MHz		1.53	1.70	1.87	V

Notes:
1. The A/D conversion result will be undefined in wait mode, stop mode, power-off mode, when the flash memory stops, and in low-current-consumption mode. Do not perform A/D conversion in these states or transition to these states during A/D conversion.
2. This applies when the peripheral functions are stopped.
3. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Table 5.33 Temperature Sensor Characteristics
(VSS = 0 V and Topr = –20 to 85 °C (N version)/–40 to 85 °C (D version), unless otherwise specified.)

Symbol	Parameter	Conditions	Standard			Unit
			Min.	Typ.	Max.	
VTMP	Temperature sensor output voltage	1.8 V ≤ Vref = AVcc ≤ 5.5 V ϕAD = 1.0 MHz to 5.0 MHz Ambient temperature = 25 °C	550	600	650	mV
–	Temperature coefficient	1.8 V ≤ Vref = AVcc ≤ 5.5 V ϕAD = 1.0 MHz to 5.0 MHz Ambient temperature = 25 °C	–	–2.1	–	mV/°C
–	Start-up time	1.8 V ≤ Vref = AVcc ≤ 5.5 V ϕAD = 1.0 MHz to 5.0 MHz	–	–	200	µs
ITMP	Operating current	1.8 V ≤ Vref = AVcc ≤ 5.5 V ϕAD = 1.0 MHz to 5.0 MHz	–	100	–	µA

Table 5.40 Voltage Detection 2 Circuit Characteristics
(V_{CC} = 1.8 to 5.5 V and T_{opr} = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

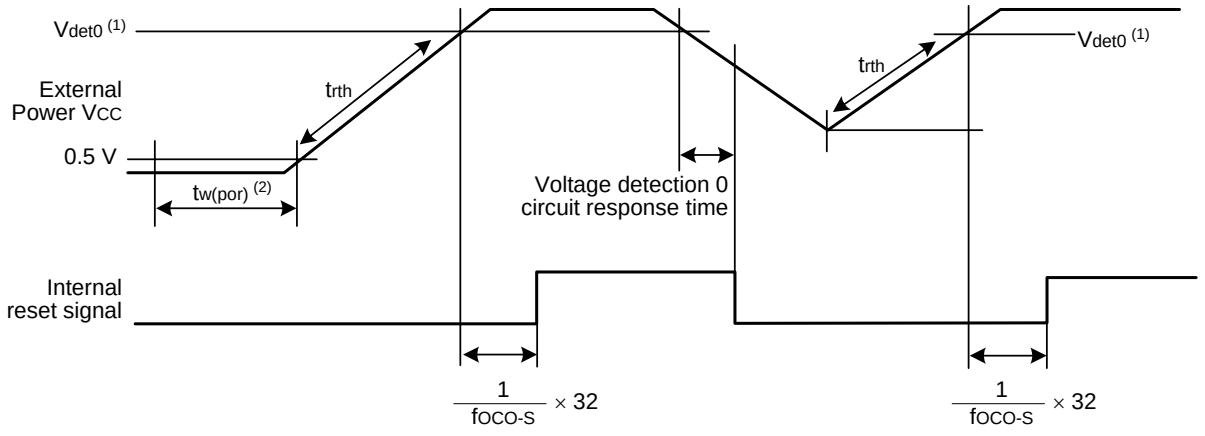
Symbol	Parameter	Condition		Standard			Unit
				Min.	Typ.	Max.	
V_{det2}	Voltage detection level Vdet2_0 (1)	At the falling of V_{CC}		3.70	4.0	4.30	V
–	Hysteresis width at the rising of Vcc in voltage detection 2 circuit			–	0.10	–	V
–	Voltage detection 2 circuit response time (2)	In operation	At the falling of Vcc from 5 V to (Vdet2_0 – 0.1) V	–	20	150	µs
		In stop mode	At the falling of Vcc from 5 V to (Vdet2_0 – 0.1) V	–	200	500	µs
–	Voltage detection circuit self power consumption	VCA27 = 1, V_{CC} = 5.0 V		–	1.7	–	µA
$t_{d(E-A)}$	Waiting time until voltage detection circuit operation starts (3)			–	–	100	µs

Notes:
1. The voltage detection level varies with detection targets. Select the level with the VCA24 bit in the VCA2 register.
2. Time until the voltage monitor 2 interrupt request is generated after the voltage passes V_{det2}.
3. Necessary time until the voltage detection circuit operates after setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.

Table 5.41 Power-on Reset Circuit Characteristics (1)
(T_{opr} = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
t_{rth}	External power V_{CC} rise gradient		0	–	50000	mV/ms

Note:
1. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0.



Notes:
1. V_{det0} indicates the voltage detection level of the voltage detection 0 circuit. Refer to **6. Voltage Detection Circuit** in the User's Manual: Hardware for details.
2. $t_{w(por)}$ indicates the duration the external power V_{CC} must be held below the valid voltage (0.5 V) to enable a power-on reset. When turning on the power after it falls with voltage monitor 0 reset disabled, maintain $t_{w(por)}$ for 1 ms or more.

Figure 5.14 Power-on Reset Circuit Characteristics

Table 5.48 DC Characteristics (2) [4.0 V ≤ Vcc ≤ 5.5 V]
(Topr = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

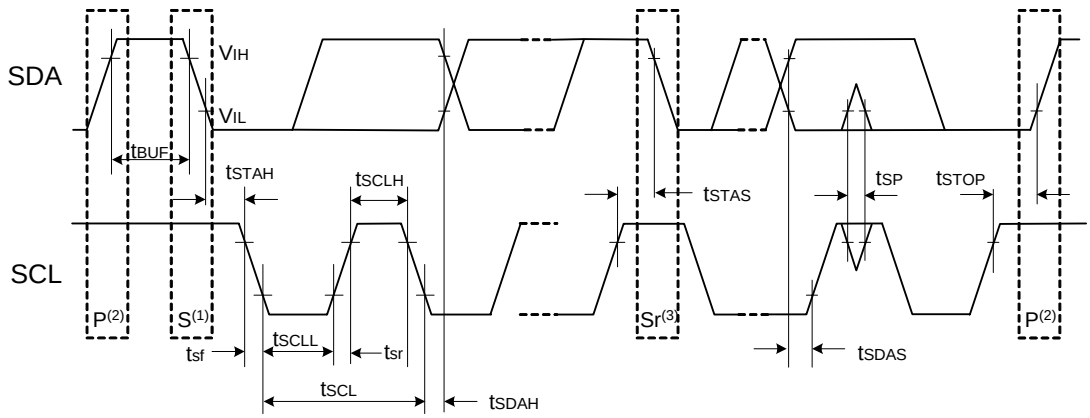
Symbol	Parameter	Condition								Standard			Unit
			Oscillation Circuit		On-Chip Oscillator		CPU Clock	Low-Power-Consumption Setting	Other	Min.	Typ. (3)	Max.	
			XIN (2)	XCIN	High-Speed	Low-Speed							
Icc	Power supply current (1)	High-speed clock mode	20 MHz	Off	Off	125 kHz	No division	–		–	4.7	10	mA
			16 MHz	Off	Off	125 kHz	No division	–		–	3.9	8	mA
			10 MHz	Off	Off	125 kHz	No division	–		–	2.3	–	mA
			20 MHz	Off	Off	Off	No division	FMR27 = 1 MSTCR0 = BEh MSTCR1 = 3Fh	Flash memory off Program operation on RAM Module standby setting enabled	–	3.1	–	mA
			20 MHz	Off	Off	125 kHz	Divide-by-8	–		–	1.8	–	mA
			16 MHz	Off	Off	125 kHz	Divide-by-8	–		–	1.5	–	mA
			10 MHz	Off	Off	125 kHz	Divide-by-8	–		–	1.0	–	mA
		High-speed on-chip oscillator mode	Off	Off	20 MHz	125 kHz	No division	–		–	5.0	11	mA
			Off	Off	20 MHz	125 kHz	Divide-by-8	–		–	2.1	–	mA
			Off	Off	4 MHz	125 kHz	Divide-by-16	MSTCR0 = BEh MSTCR1 = 3Fh		–	0.9	–	mA
		Low-speed on-chip oscillator mode	Off	Off	Off	125 kHz	No division	FMR27 = 1 VCA20 = 0		–	110	320	µA
			Off	Off	Off	125 kHz	Divide-by-8	FMR27 = 1 VCA20 = 0		–	63	220	µA
		Low-speed clock mode	Off	32 kHz	Off	Off	No division	FMR27 = 1 VCA20 = 0		–	60	220	µA
			Off	32 kHz	Off	Off	No division	FMSTP = 1 VCA20 = 0	Flash memory off Program operation on RAM	–	46	–	µA
		Wait mode	Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1	While a WAIT instruction is executed Peripheral clock operation	–	9.0	50	µA
			Off	Off	Off	125 kHz	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off	–	2.8	33	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 0	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode LCD drive control circuit (4) When external division resistors are used	–	4.6	–	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 VCA20 = 1 CM02 = 1 CM01 = 1	While a WAIT instruction is executed Peripheral clock off Timer RH operation in real-time clock mode	–	2.4	–	µA
		Stop mode	Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 25°C Peripheral clock off	–	0.5	2.2	µA
			Off	Off	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Topr = 85°C Peripheral clock off	–	1.2	–	µA
		Power-off mode	Off	Off	Off	Off	–	–	Power-off 0 Topr = 25°C	–	0.01	0.1	µA
			Off	Off	Off	Off	–	–	Power-off 0 Topr = 85°C	–	0.03	–	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 25°C	–	1.8	6.4	µA
			Off	32 kHz	Off	Off	–	VCA27 = 0 VCA26 = 0 VCA25 = 0 CM10 = 1	Power-off 2 Topr = 85°C	–	2.7	–	µA

Notes:
1. Vcc = 4.0 V to 5.5 V, single chip mode, output pins are open, and other pins are Vss.
2. XIN is set to square wave input.
3. Vcc = 5.0 V
4. VLCD = Vcc, external division resistors are used for VL3 to VL1, 1/3 bias, 1/4 duty, f(FR) = 64 Hz, SEG0 to SEG39 are selected, and segment and common output pins are open. The standard value does not include the current that flows through external division resistors.

Table 5.54 Timing Requirements of I²C bus Interface (1)
(Vcc = 1.8 to 5.5 V, Vss = 0 V, and Topr = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Condition	Standard			Unit
			Min.	Typ.	Max.	
tSCL	SCL input cycle time		12tCYC + 600 (1)	–	–	ns
tSCLH	SCL input “H” width		3tCYC + 300 (1)	–	–	ns
tSCLL	SCL input “L” width		5tCYC + 500 (1)	–	–	ns
tsf	SCL, SDA input fall time		–	–	300	ns
tSP	SCL, SDA input spike pulse rejection time		–	–	1tCYC (1)	ns
tBUF	SDA input bus-free time		5tCYC (1)	–	–	ns
tSTAH	Start condition input hold time		3tCYC (1)	–	–	ns
tSTAS	Retransmit start condition input setup time		3tCYC (1)	–	–	ns
tSTOP	Stop condition input setup time		3tCYC (1)	–	–	ns
tSDAS	Data input setup time		1tCYC + 40 (1)	–	–	ns
tSDAH	Data input hold time		10	–	–	ns

Note:
1. 1tCYC = 1/f1(s)



Notes:
1. Start condition
2. Stop condition
3. Retransmit start condition

Figure 5.18 I/O Timing of I²C bus Interface

Table 5.55 Timing Requirements of External Clock Input (XIN, XCIN)
(Vss = 0 V and Topr = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Standard						Unit
		Vcc = 2.2V, Topr = 25°C		Vcc = 3V, Topr = 25°C		Vcc = 5V, Topr = 25°C		
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{c(XIN)}$	XIN input cycle time	200	–	50	–	50	–	ns
$t_{WH(XIN)}$	XIN input “H” width	90	–	24	–	24	–	ns
$t_{WL(XIN)}$	XIN input “L” width	90	–	24	–	24	–	ns
$t_{c(XCIN)}$	XCIN input cycle time	20	–	20	–	20	–	µs
$t_{WH(XCIN)}$	XCIN input “H” width	10	–	10	–	10	–	µs
$t_{WL(XCIN)}$	XCIN input “L” width	10	–	10	–	10	–	µs

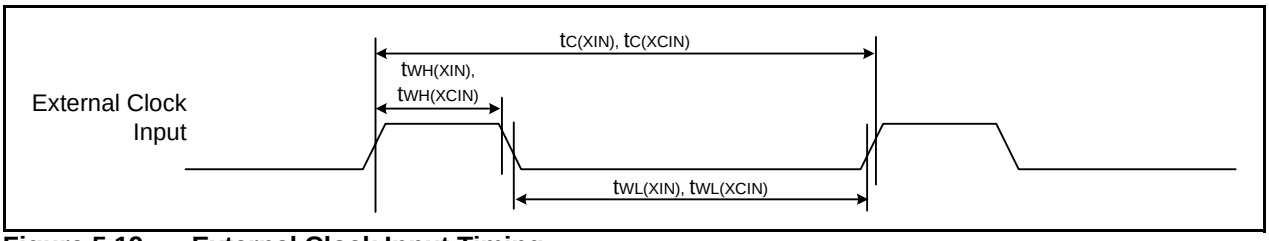


Figure 5.19 External Clock Input Timing

Table 5.56 Timing Requirements of TRJiIO (i = 0 to 2)
(Vss = 0 V and Topr = –20 to 85°C (N version)/ –40 to 85°C (D version), unless otherwise specified.)

Symbol	Parameter	Standard						Unit
		Vcc = 2.2V, Topr = 25°C		Vcc = 3V, Topr = 25°C		Vcc = 5V, Topr = 25°C		
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{c(TRJIO)}$	TRJiIO input cycle time	500	–	300	–	100	–	ns
$t_{WH(TRJIO)}$	TRJiIO input “H” width	200	–	120	–	40	–	ns
$t_{WL(TRJIO)}$	TRJiIO input “L” width	200	–	120	–	40	–	ns

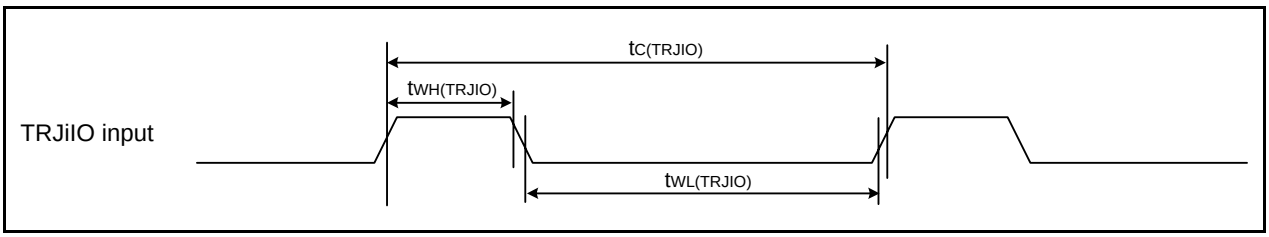


Figure 5.20 Input Timing of TRJiIO

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